Specifications for Approval

Customer Part No.:

Inhere Part No.: S5050NPUET-001

Part Name: 5050 三晶红光 LED

Spec Issue Date: 2018-07-23

Revision No.: A

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To Customer:

We submit herewith the following information for your approval:

■Sample ☐OQC Inspection Record ■LED Dimension

■Electrical Characteristics Curve ■Internal Circuit Diagram

■Soldering recommendation

Prepared by: Lily	Checked by: Tom	Approved by: Wangxiaojun
Date: 2018-07-23	Date: 2018-07-23	Date: 2018-07-23

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Customer Opinion

☐ Approve and no objection

☐ Reject with the following reason:

_____

东莞市银河光电有限公司
DongGuan Inhere Opto CO.,LTD.
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Http://www.inhereopto.com

Features

5.0mm x 5.0mm TOP LED, 1.5mm thickness

Low power consumption

Wide view angle

Package: 1000pcs/reel

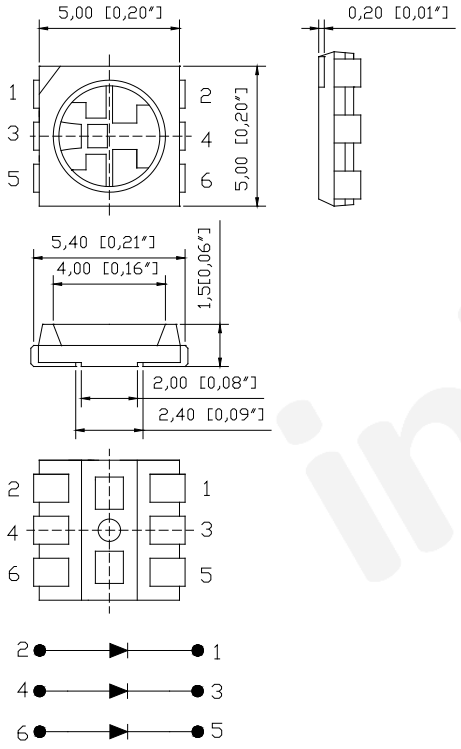
RoHS Compliant

Applications

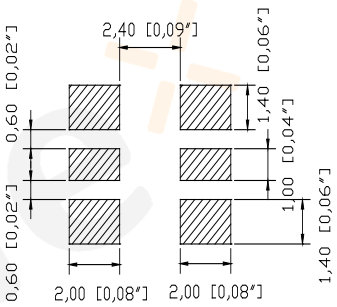
Ideal for back light and indicator

Various colors and lens types available

Package outlines



Recommend Pad Layout



Part No.	Emitted color	Dice	Lens color
S5050NPUET-001	Red	AlGaInP	Water transparent

Notes:

All dimensions are in millimeters (inches);

Tolerances are ±0.1mm (0.004inch) unless otherwise noted.

Absolute Maximum Ratings (Ta=25℃)

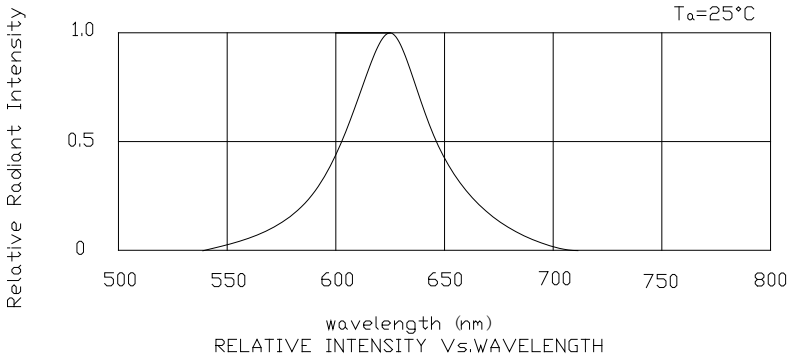
Parameter	Symbol	Value	Unit
Power dissipation	Pd	144	mW
Forward current	If	60	mA
Reverse voltage	Vr	5	V
Operating temperature	Top	-40 ~+80	℃
Storage temperature	Tstg	-40 ~+85	℃
Peak pulsing current (1/8 duty f=1kHz)	Ifp	100	mA

Electro-Optical Characteristics (Ta=25℃)

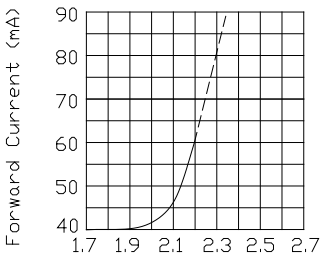
Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	If=60mA	λp	--	630		nm
Spectral half bandwidth	If=60mA	△λ		20		nm
Dominant wavelength	If=60mA	λd	620	--	630	nm
Forward voltage	If=60mA	Vf	1.8	--	2.4	V
Luminous intensity	If=60mA	Iv	1500	2500	--	mcd
Viewing angle at 50% Iv	If=60mA	2θ1/2	--	120	--	Deg
Reverse current	Vr=5V	Ir	--	10	μA	

Note:
1. The tolerance of forward voltage is ±0.05V
2. The tolerance of luminous intensity (Iv)is ±15％.
3. The tolerance of dominant wavelength is ±1nm.
4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

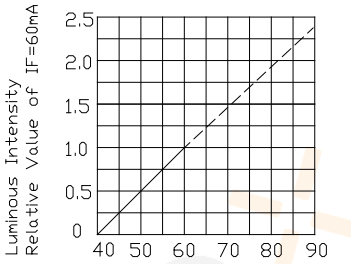
Optical Characteristic Curves



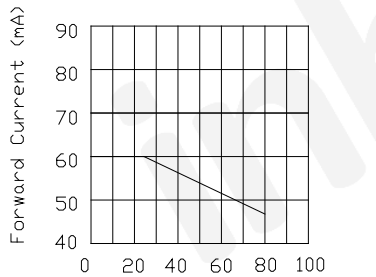
RELATIVE INTENSITY Vs.WAVELENGTH



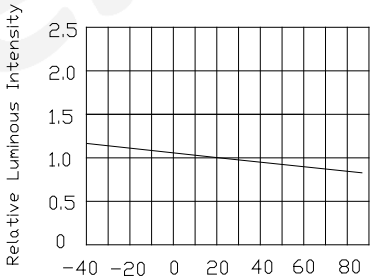
FORWARD CURRENT Vs.
FORWARD VOLTAGE



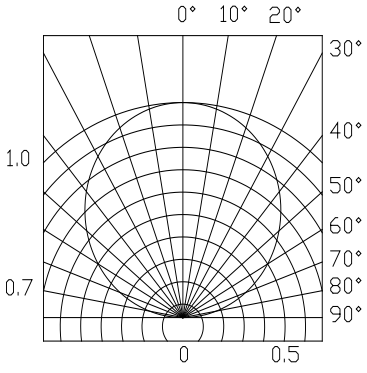
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURE



LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



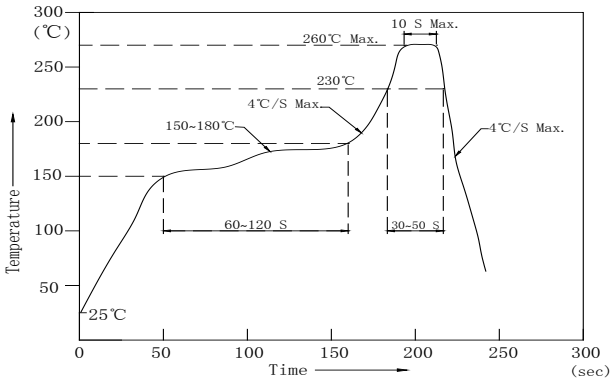
SPATIAL DISTRIBUTION

Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5℃,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5～7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min ↑→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃～100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃～65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH～55%RH	--	1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

Reflow Profile

■ Reflow Temp/Time



Notes:

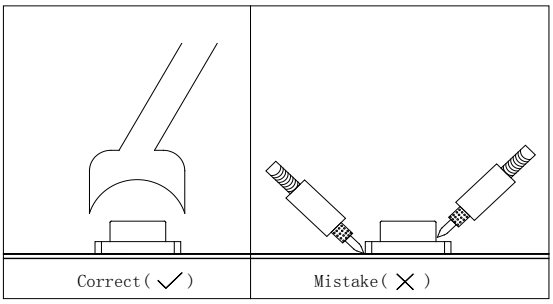
1. We recommend the reflow temperature 245℃ (±5℃).the maximum soldering temperature should be limited to 260℃.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is ≤ 5sec when 320℃ (±20℃). If temperature is higher, time should be shorter (+10℃→ -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350℃.

■Rework

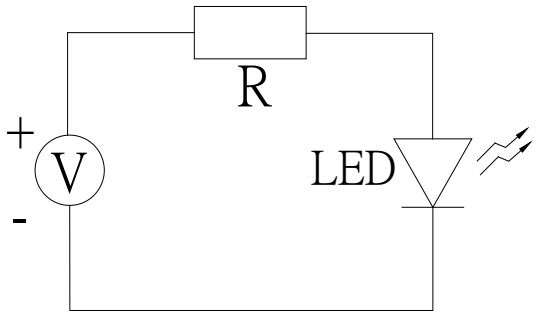
1. Customer must finish rework within 5 sec under 340℃.
2. The head of iron cannot touch copper foil
3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5℃~30℃

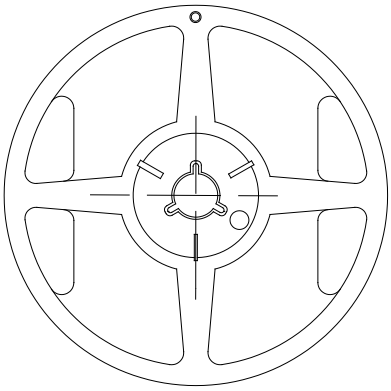
2.2 Shelf life in sealed bag: 12 month at ＜5℃~30℃ and ＜30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at≦20 R.H. with zip-lock sealed.

3. Baking

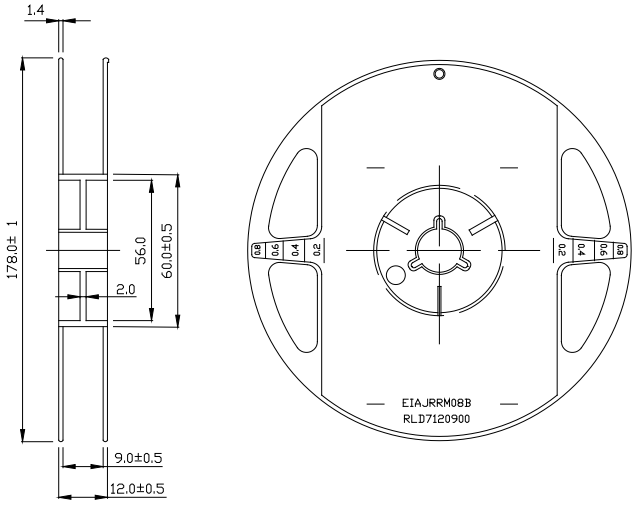
It is recommended to baking before soldering. The Conditions is: 60±5℃/24hrs.

5050 Series SMD Top LED Lamps Packaging Specifications

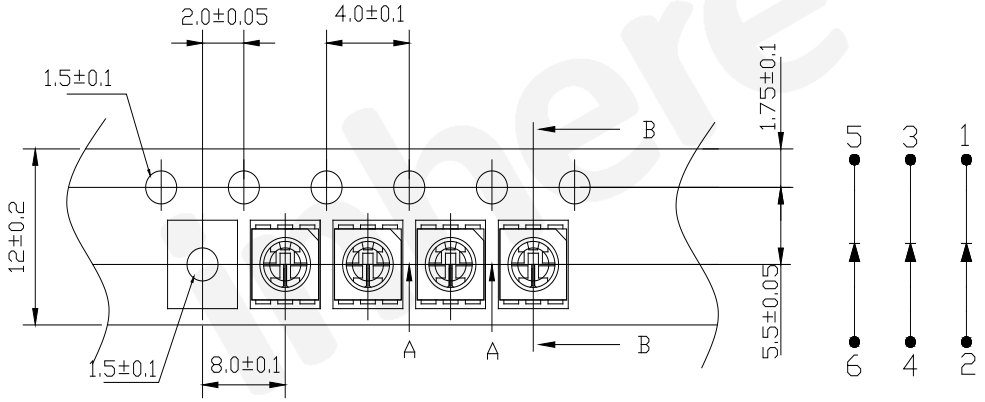
- **Feeding Direction**



- **Dimensions of Reel (Unit: mm)**



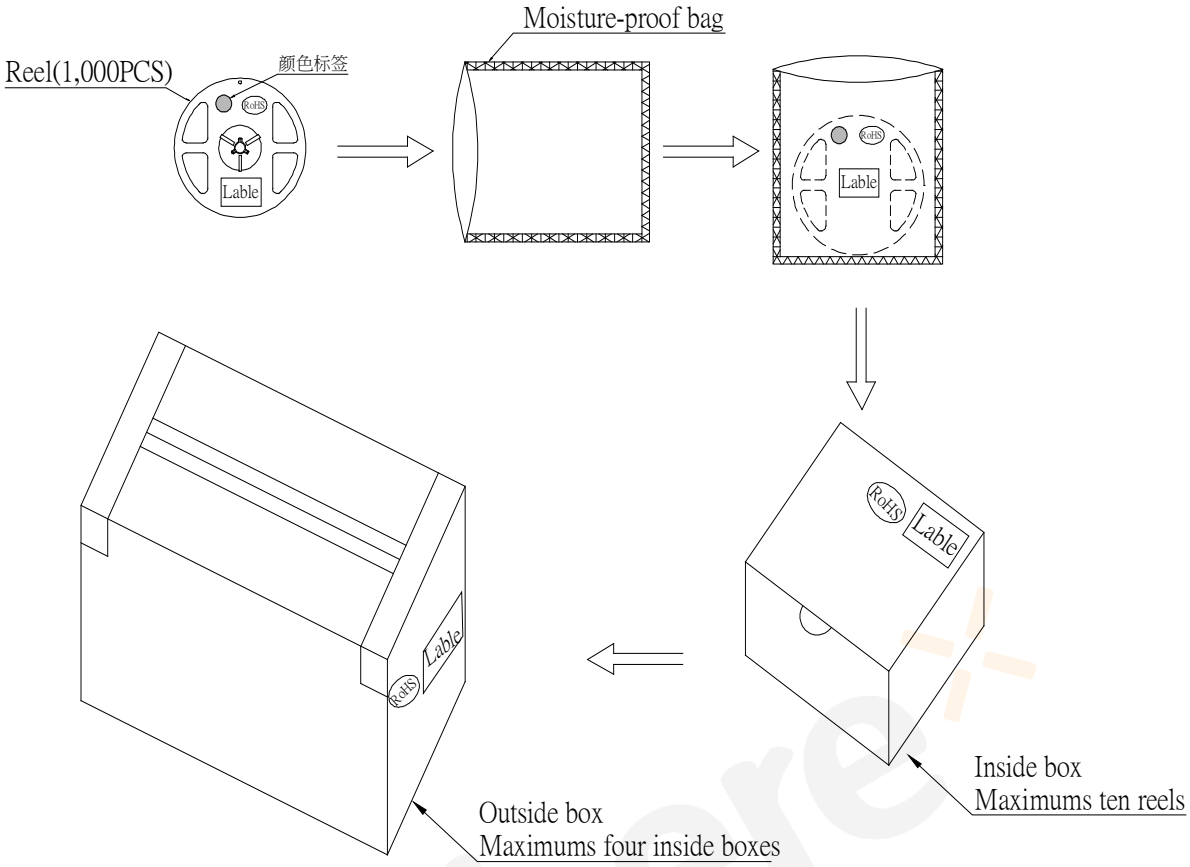
- **Dimensions of Tape (Unit: mm)**



Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 1,000pcs/Reel.

5050 Series SMD Top LED Lamps Packaging Specifications



Notes:

Reeled products (numbers of products are 1000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 10000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.